

TRANSMITTAL OF FORMAL DRAWINGS

Docket No.
YOR920030336US1 (16898)

In Re Application Of: Timothy J. Dalton, et al.

Application No.	Filing Date	Confirmation No.	Examiner	Customer No.	Group Art Unit
10/685,012	10/14/03	4288	Edgardo Ortiz	23389	2815

Invention: PHOTORESIST ASH PROCESS WITH REDUCED INTER-LEVEL DIELECTRIC (ILD) DAMAGE

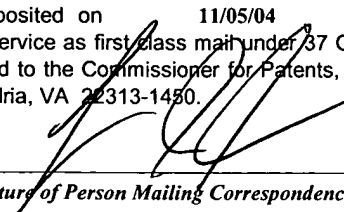
Address to:
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Transmitted herewith are:

2 sheets of formal drawing(s) for this application.

☒ Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).
SignatureLeslie S. Szivos, Ph.D.
Registration No. 39,394

Dated: November 5, 2004

I certify that this document and attached formal drawings
are being deposited on 11/05/04 with the
U.S. Postal Service as first class mail under 37 C.F.R. 1.8
and addressed to the Commissioner for Patents, P.O. Box
1450, Alexandria, VA 22313-1450.
Signature of Person Mailing Correspondence

Leslie S. Szivos, Ph.D.

Typed or Printed Name of Person Mailing Correspondence